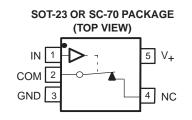


Description

The MAX4597 is a single-pole single-throw (SPST) analog switch that is designed to operate from 2 V to 5.5 V. This device can handle both digital and analog signals, and signals up to V_+ can be transmitted in either direction.

Applications

- Sample-and-Hold Circuits
- Battery-Powered Equipment (Cellular Phones, PDAs)
- Audio and Video Signal Routing
- Communication Circuits
- PCMCIA Cards



FUNCTION TABLE

| IN | NC TO COM, COM TO NC |
|----|-------------------------|
| L | ON |
| н | OFF |

Features

- Low ON-State Resistance (10 Ω)
- ON-State Resistance Flatness (1.5 Ω)
- Control Inputs Are 5.5-V Tolerant
- Low Charge Injection (5 pC Max)
- 300-MHz –3-dB Bandwidth at 25°C
- Low Total Harmonic Distortion (THD) (0.05%)
- 2-V to 5.5-V Single-Supply Operation
- Specified at 5-V and 3.3-V Nodes
- -83-dB OFF Isolation at 1 MHz
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- 0.5-nA Max OFF Leakage
- ESD Performance Tested Per JESD 22

 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)
- TTL/CMOS-Logic Compatible

Summary of Characteristics

 $V_{+} = 5 V, T_{A} = 25^{\circ}C$

| Configuration | Single Pole Single Throw (SPST) |
|--|---------------------------------------|
| Number of channels | 1 |
| ON-state resistance (r _{on}) | 10 Ω |
| ON-state resistance flatness (ron(flat)) | 1.5 Ω |
| Turn-on/turn-off time (tON/tOFF) | 35 ns/40 ns |
| Charge injection (Q _C) | 5 pC |
| Bandwidth (BW) | 300 MHz |
| OFF isolation (OISO) | –83 dB at 1 MHz |
| Total harmonic distortion (THD) | 0.05% |
| Leakagecurrent(ICOM(OFF)/INC(OFF)) | ±0.05 nA |
| Power-supply current (I+) | 1 μΑ |
| Package option | 5-pin SOT-23 or SC-70 |

ORDERING INFORMATION

| Τ _Α | PACKAGE(1) | | ORDERABLE PART NUMBER | TOP-SIDE MARKING ⁽²⁾ |
|----------------|--------------------|---------------|-----------------------|---------------------------------|
| 4000 4 0500 | SOT (SOT-23) – DBV | Tape and reel | MAX4597DBVR | 6SD_ |
| –40°C to 85°C | SOT (SC-70) - DCK | Tape and reel | MAX4597DCKR | SD_ |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
(2) DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site.

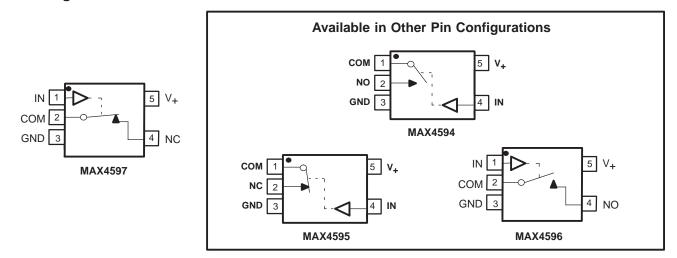
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

MAX4597 SINGLE-CHANNEL 10- Ω SPST ANALOG SWITCH



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Pin Configurations



Absolute Minimum and Maximum Ratings(1)(2)

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|-------------------------------------|-------------------------------------|--|------|----------------------|------|
| ۷+ | Supply voltage range ⁽³⁾ | | -0.3 | 6 | V |
| V _{NC} V _{COM} | Analog voltage range(3)(4) | | -0.3 | V ₊ + 0.3 | V |
| ١ĸ | Analog port diode current | V _{NC} , V _{COM} < 0 | -50 | | mA |
| I _{NC} I _{COM} | On-state switch current | V_{NC} , $V_{COM} = 0$ to V_+ | -20 | 20 | mA |
| VI | Digital input voltage range(3)(4) | | -0.3 | 6 | V |
| ΙIK | Digital input clamp current | V _I < 0 | -50 | | mA |
| I ₊ | Continuous current through V+ | | | 100 | mA |
| IGND | Continuous current through GND | | -100 | | mA |
| 0 | Declares the small impedance (5) | DBV package | | 206 | 0000 |
| θJA | Package thermal impedance(5) | DCK package | | 252 | °C/W |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

(3) All voltages are with respect to ground, unless otherwise specified.

(4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

(5) The package thermal impedance is calculated in accordance with JESD 51-7.

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Electrical Characteristics for 5-V Supply(1) $V_{+} = 4.5 V \text{ to } 5.5 V$, $T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITION | S | TA | V+ | MIN | TYP | MAX | UNIT |
|--------------------------|-----------------------------------|--|---------------|--------------|-------|----------|------|--------|------|
| Analog Switch | 1 | | | | | | | | |
| Analog signal range | VCOM, VNC | | | | | 0 | | V+ | V |
| ON-state | r | V _{NC} = 3.5 V, | Switch ON, | 25°C | 4.5 V | | 6.5 | 10 | Ω |
| resistance | ron | ICOM = 10 mA, | See Figure 13 | Full | 4.5 V | | | 12 | 22 |
| ON-state resistance | F (f) - () | V _{NC} = 1.5 V, 2.5 V, 3.5 V, | Switch ON, | 25°C | 4.5 V | | 0.5 | 1.5 | Ω |
| flatness | ^r on(flat) | $I_{COM} = 10 \text{ mA},$ | See Figure 13 | Full | 4.5 V | | | 2 | 52 |
| NC OFF leakage | | $V_{NC} = 1 V, V_{COM} = 4.5 V,$ | Switch OFF, | 25°C | 551 | -0.5 | 0.01 | 0.5 | |
| current | INC(OFF) | $V_{\text{NC}} = 4.5 \text{ V}, V_{\text{COM}} = 1 \text{ V},$ | See Figure 14 | Full | 5.5 V | -5 | | 5 | nA |
| COM | | $V_{COM} = 1 \text{ V}, V_{NC} = 4.5 \text{ V},$ | Switch OFF, | 25°C | | -0.5 | 0.01 | 0.5 | nA |
| OFF leakage current | ICOM(OFF) | $v_{COM} = 4.5 \text{ V}, \text{ V}_{NC} = 1 \text{ V},$ | See Figure 14 | Full | 5.5 V | -5 | | 5 | |
| NC | | $V_{NC} = 1 V, V_{COM} = 1 V,$ | Switch ON, | 25°C | 5.5 V | -1 | 0.01 | 1 | |
| ON leakage current | I _{NC} (ON) | $V_{NC} = 4.5 V, V_{COM} = 4.5 V,$ or $V_{NC} = 1 V, 4.5 V, V_{COM} = Open,$ | See Figure 15 | Full | | -10 | | 10 | nA |
| COM | | $V_{COM} = 1 V, V_{NC} = 1 V,$ | Switch ON, | 25°C | | -1 | 0.01 | 1 | |
| ON leakage current | ICOM(ON) | V _{COM} = 4.5 V, V _{NC} = 4.5 V, or V _{COM} = 1 V, 4.5 V, V _{NC} = Open, | See Figure 15 | Full | 5.5 V | -10 | | 10 | nA |
| Digital Control In | put (IN) | | | | | | | | |
| Input logic high | VIH | | | Full | | 2.4 | | 5.5 | V |
| Input logic low | VIL | | | Full | | 0 | | 0.8 | V |
| Input leakage current | I _{IH} , I _{IL} | V _I = 5.5 V or 0 | | 25°C Full | 5.5 V | -1 -1 | 0.03 | 1 1 | μA |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

MAX4597 SINGLE-CHANNEL 10- Ω SPST ANALOG SWITCH



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Electrical Characteristics for 5-V Supply⁽¹⁾ (continued) $V_{+} = 4.5 V \text{ to } 5.5 V$, $T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CON | DITIONS | TA | V+ | MIN | TYP | MAX | UNIT |
|----------------------------|----------------------|---|---|------|----------------|-----|------|-----|------|
| Dynamic | • | | | • | | | | | |
| Turn-on time | 4 | V _{NC} = 3 V, | C _L = 35 pF, | 25°C | 5 V | | 20 | 35 | |
| rum-on time | ton | RL = 300 Ω, | See Figure 17 | Full | 4.5 V to 5.5 V | | | 45 | ns |
| Turn-off time | torr | V _{NC} = 3 V, | C _L = 35 pF, | 25°C | 5 V | | 25 | 40 | ns |
| | tOFF | R _L = 300 Ω, | See Figure 17 | Full | 4.5 V to 5.5 V | | | 50 | 115 |
| Charge injection | QC | V _{GEN} = 0, R _{GEN} = 0, | C _L = 1 nF, See Figure 20 | 25°C | 5 V | | 2 | 5 | pC |
| NC OFF capacitance | C _{NC(OFF)} | V _{NC} = 0, f = 1 MHz, | Switch OFF, See Figure 16 | 25°C | 5 V | | 8 | | pF |
| COM OFF capacitance | CCOM(OFF) | V _{COM} = 0, f = 1 MHz, | Switch OFF, See Figure 16 | 25°C | 5 V | | 8 | | pF |
| NC ON capacitance | C _{NC(ON))} | V _{NC} = 0, f = 1 MHz, | Switch ON, See Figure 16 | 25°C | 5 V | | 20 | | pF |
| COM ON capacitance | C _{COM(ON)} | V _{COM} = 0, f = 1 MHz, | Switch ON, See Figure 16 | 25°C | 5 V | | 20 | | pF |
| Digital input capacitance | CI | $V_{I} = V_{+} \text{ or GND},$ | See Figure 16 | 25°C | 5 V | | 3 | | pF |
| Bandwidth | BW | $R_L = 50 \Omega$, Signal = 0 dBm, | Switch ON, See Figure 18 | 25°C | 5 V | | 300 | | MHz |
| OFF isolation | O _{ISO} | $\label{eq:RL} \begin{split} R_{L} &= 50 \ \Omega, \ f = 10 \ MHz, \\ V_{NC} &= 1 \ V_{RMS}, \end{split}$ | Switch OFF, See Figure 19 | 25°C | 5 V | | -83 | | dB |
| Total harmonic distortion | THD | $R_L = 600 \Omega$, $C_L = 50 pF$, VSOURCE = 5 V _{p-p} , | f = 20 Hz to 20 kHz, See Figure 21 | 25°C | 5 V | | 0.05 | | % |
| Supply | | | | | | | | | |
| Positive supply current | I+ | $V_{I} = V_{+} \text{ or GND},$ | Switch ON or OFF | Full | 5.5 V | | | 1 | μΑ |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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Electrical Characteristics for 3-V Supply(1) $V_{+} = 2.7 V \text{ to } 3.6 V$, $T_{A} = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CO | ONDITIONS | TA | V+ | MIN | TYP | MAX | UNIT | |
|-------------------------|---------------------------------------|--|------------------|------|----------------|-----|------|-----|------|--|
| Analog Switch | • | · | | | | | | | | |
| Analog signal range | V _{COM} , V _{NC} | | | | | 0 | | V+ | V | |
| ON-state | | V _{NC} = 1.5 V, | Switch ON, | 25°C | 0.71/ | | 10 | 20 | _ | |
| resistance | ron | I _{COM} = 10 mA, | See Figure 13 | Full | 2.7 V | | | 25 | Ω | |
| Digital Control In | out (IN) | | | | | | | | | |
| Input logic high | VIH | | | Full | | 2 | | 5.5 | V | |
| Input logic low | VIL | | | Full | | 0 | | 0.8 | V | |
| Input leakage | | V V 0 | | 25°C | 0.01/ | -1 | 0.03 | 1 | | |
| current | IIH, IIL | $V_{I} = V_{+} \text{ or } 0$ | | Full | 3.6 V | -1 | | 1 | μA | |
| Dynamic | | • | | | | | | | | |
| Turn-on time | | $V_{COM} = 2 V,$ | CL = 35 pF, | 25°C | 3 V | | 25 | 45 | | |
| rum-on ume | tON | RL = 300 Ω, | See Figure 17 | Full | 2.7 V to 3.6 V | | | 55 | ns | |
| Turn-off time | | $V_{COM} = 2 V,$ | CL = 35 pF, | 25°C | 3 V | | 30 | 50 | | |
| rum-oir iime | tOFF | $R_L = 300 \Omega$, | See Figure 17 | Full | 2.7 V to 3.6 V | | | 60 | ns | |
| Charge injection | QC | $V_{NC} = 0,$ $C_L = 1 \text{ nF},$ | See Figure 20 | 25°C | 3 V | | 2 | 4 | рС | |
| Supply | | | | | | | | | | |
| Positive supply current | I+ | $V_{I} = V_{+} \text{ or GND},$ | Switch ON or OFF | Full | 3.6 V | | | 1 | μΑ | |

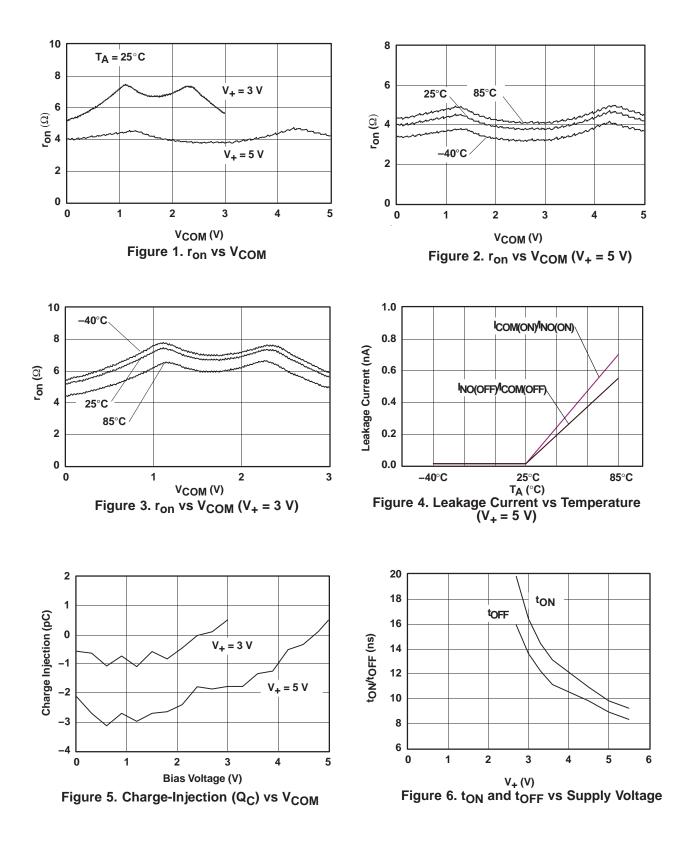
(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

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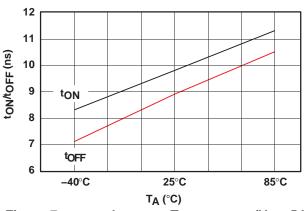






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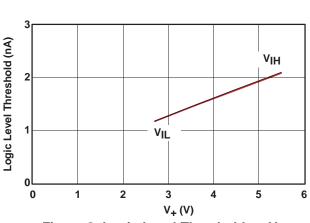
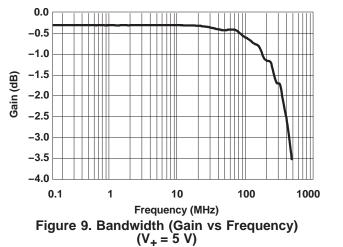
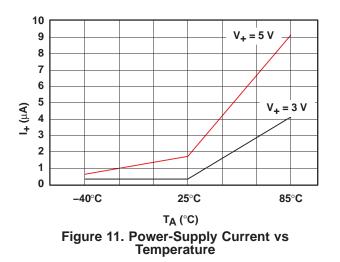


Figure 8. Logic-Level Threshold vs V₊





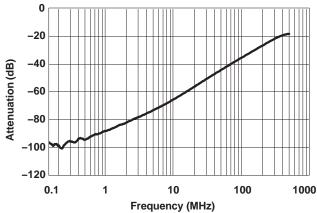
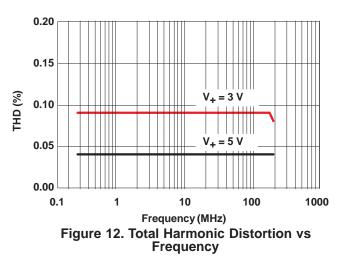


Figure 10. Off Isolation vs Frequency



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PIN DESCRIPTION

| PIN NUMBER | NAME | DESCRIPTION |
|------------|------|--|
| 1 | IN | Digital control pin to connect COM to NC |
| 2 | COM | Common |
| 3 | GND | Digital ground |
| 4 | NC | Normally closed |
| 5 | V+ | Power supply |

PARAMETER DESCRIPTION

| SYMBOL | DESCRIPTION |
|------------------------|---|
| VCOM | Voltage at COM |
| V _{NC} | Voltage at NC |
| ron | Resistance between COM and NC ports when the channel is ON |
| ^r on(flat) | Difference between the maximum and minimum value of ron in a channel over the specified range of conditions |
| INC(OFF) | Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state |
| I _{NC(ON)} | Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) open |
| ICOM(OFF) | Leakage current measured at the COM port, with the corresponding channel (COM to NC) in the OFF state |
| ICOM(ON) | Leakage current measured at the COM port, with the corresponding channel (COM to NC) in the ON state and the output (NC) open |
| VIH | Minimum input voltage for logic high for the control input (IN) |
| VIL | Maximum input voltage for logic low for the control input (IN) |
| VI | Voltage at the control input (IN) |
| IIH, IIL | Leakage current measured at the control input (IN) |
| ^t ON | Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NC) signal when the switch is turning ON. |
| tOFF | Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM or NC) signal when the switch is turning OFF. |
| QC | Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NC or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$, C_L is the load capacitance, and ΔV_{COM} is the change in analog output voltage. |
| C _{NC(OFF)} | Capacitance at the NC port when the corresponding channel (NC to COM) is OFF |
| C _{NC(ON)} | Capacitance at the NC port when the corresponding channel (NC to COM) is ON |
| C _{COM} (OFF) | Capacitance at the COM port when the corresponding channel (COM to NC) is OFF |
| C _{COM} (ON) | Capacitance at the COM port when the corresponding channel (COM to NC) is ON |
| Cl | Capacitance of control input (IN) |
| 0 _{ISO} | OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NC to COM) in the OFF state. |
| BW | Bandwidth of the switch. This is the frequency in which the gain of an ON channel is -3 dB below the DC gain. |
| THD | Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of the fundamental harmonic. |
| l ₊ | Static power-supply current with the control (IN) pin at V+ or GND |



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PARAMETER MEASUREMENT INFORMATION

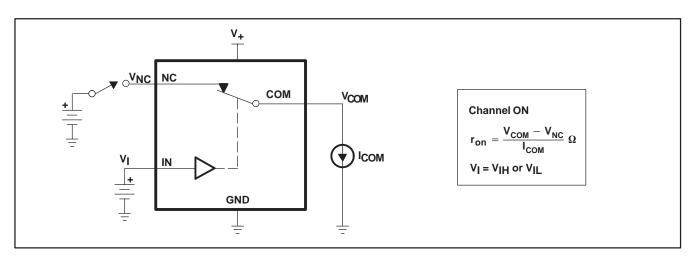


Figure 13. ON-State Resistance (ron)

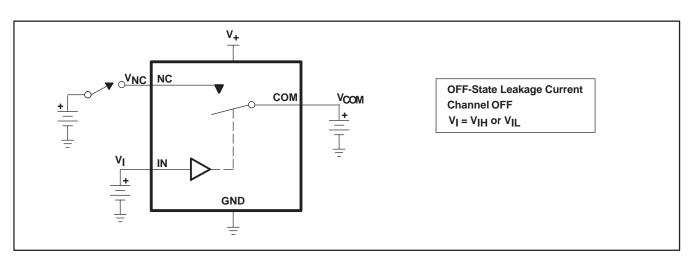
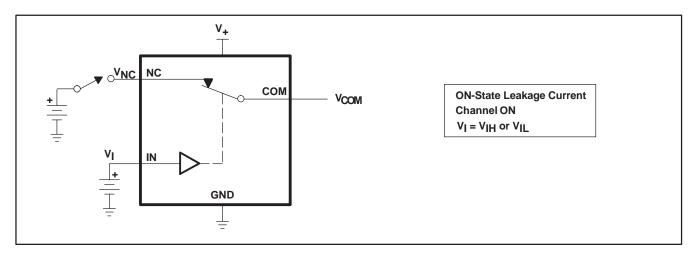


Figure 14. OFF-State Leakage Current (I_{COM(OFF)}, I_{NC(OFF)})

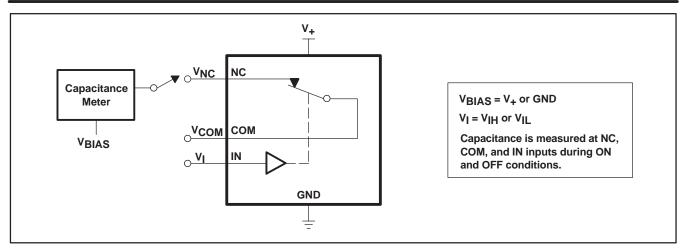




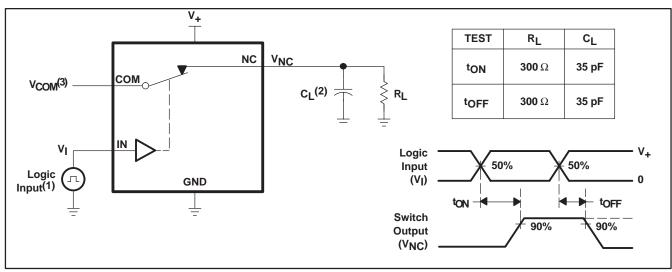
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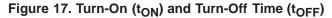




(1) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f < 5 ns, t_f < 5 ns.

(2) C_L includes probe and jig capacitance.

(3) See Electrical Characteristics for V_{COM}.



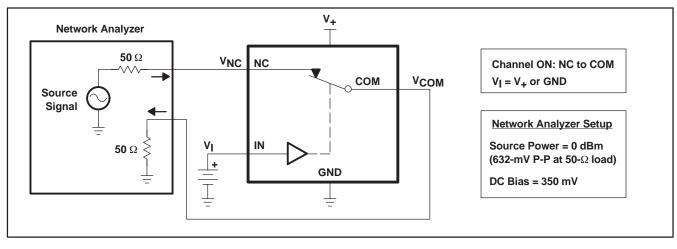


Figure 18. Bandwidth (BW)



$\begin{array}{l} \text{MAX4597} \\ \text{SINGLE-CHANNEL 10-} \Omega \text{ SPST ANALOG SWITCH} \end{array}$

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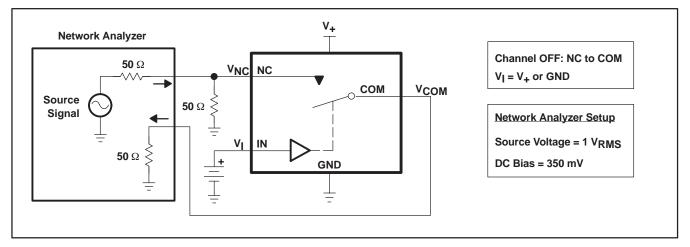
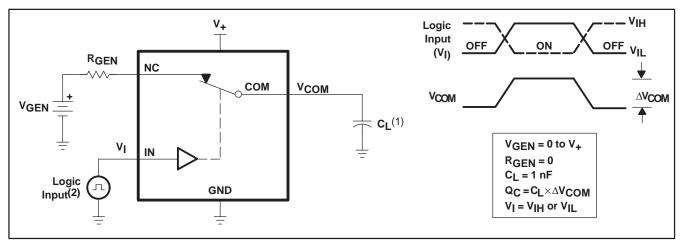


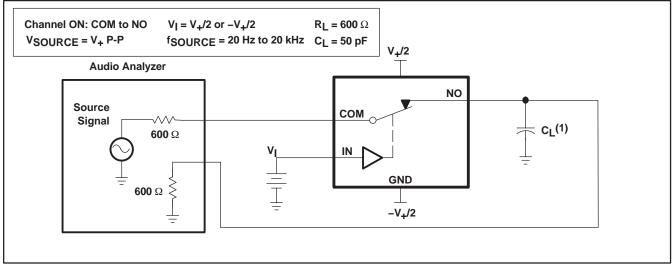
Figure 19. OFF Isolation (OISO)



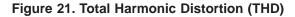
(1) C_L includes probe and jig capacitance.

(2) All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f < 5 ns, t_f < 5 ns.

Figure 20. Charge Injection (Q_C)



(1) CL includes probe and jig capacitance.





PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ | MSL rating/ | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|------------------|-----------------------|------|---------------|--------------------|--------------|--------------|
| | (1) | (2) | | | (3) | Ball material | Peak reflow | | (6) |
| | | | | | | (4) | (5) | | |
| MAX4597DBVR | Active | Production | SOT-23 (DBV) 5 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | 6SDR |
| MAX4597DBVR.B | Active | Production | SOT-23 (DBV) 5 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | 6SDR |
| MAX4597DCKR | Active | Production | SC70 (DCK) 5 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | SDR |
| MAX4597DCKR.B | Active | Production | SC70 (DCK) 5 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | SDR |

⁽¹⁾ **Status:** For more details on status, see our product life cycle.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

www.ti.com

Texas Instruments

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| MAX4597DBVR | SOT-23 | DBV | 5 | 3000 | 180.0 | 8.4 | 3.23 | 3.17 | 1.37 | 4.0 | 8.0 | Q3 |
| MAX4597DCKR | SC70 | DCK | 5 | 3000 | 180.0 | 8.4 | 2.47 | 2.3 | 1.25 | 4.0 | 8.0 | Q3 |

TEXAS INSTRUMENTS

www.ti.com

PACKAGE MATERIALS INFORMATION

3-Aug-2017



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| MAX4597DBVR | SOT-23 | DBV | 5 | 3000 | 202.0 | 201.0 | 28.0 |
| MAX4597DCKR | SC70 | DCK | 5 | 3000 | 202.0 | 201.0 | 28.0 |

DBV0005A



PACKAGE OUTLINE

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



DBV0005A

EXAMPLE BOARD LAYOUT

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DBV0005A

EXAMPLE STENCIL DESIGN

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



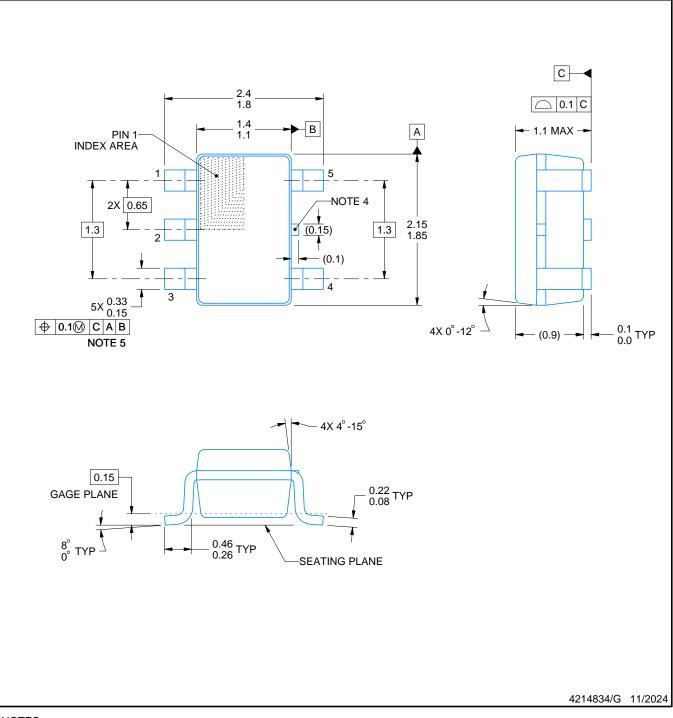
DCK0005A



PACKAGE OUTLINE

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC MO-203.

- 4. Support pin may differ or may not be present.5. Lead width does not comply with JEDEC.
- 6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



DCK0005A

EXAMPLE BOARD LAYOUT

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

Publication IPC-7351 may have alternate designs.
Solder mask tolerances between and around signal pads can vary based on board fabrication site.



DCK0005A

EXAMPLE STENCIL DESIGN

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

10. Board assembly site may have different recommendations for stencil design.



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